BOARD's DRILL SCHEDULE

<table>
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<tr>
<th>DRILL SYMBOL</th>
<th>DRILL SIZE</th>
<th>COUNT</th>
<th>PLATED</th>
<th>Tolerance</th>
<th>COMMENT</th>
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<td>.05</td>
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</table>

Layer Order:
4-Layer Flex PCB - 90x53 mm, 0.062" Thick

Board Characteristics:
1. Material - RF4 - Tg > 170°C
2. Minimum trace width: 5 mils
3. 1 Oz Copper on all layers
5. Polymide Coverlay (Kapton Soldermask) on Top and Bottom, as per Gerbers

**Layer Order:**
- Film 1 - Top
- Film 2 - Power
- Film 3 - Signal 3
- Film 4 - Bottom

**Board Characteristics:**
1. Material - RF4 - Tg > 170°C
2. Minimum trace width: 5 mils
3. 1 Oz Copper on all layers
5. Polymide Coverlay (Kapton Soldermask) on Top and Bottom, as per Gerbers